CPC  COOPERATIVE PATENT CLASSIFICATION

C  CHEMISTRY; METALLURGY
(NOTES omitted)

CHEMISTRY

C09  DYSES; PAINTS; POLISHES; NATURAL RESINS; ADHESIVES; COMPOSITIONS NOT OTHERWISE PROVIDED FOR; APPLICATIONS OF MATERIALS NOT OTHERWISE PROVIDED FOR

C09G  POLISHING COMPOSITIONS OTHER THAN FRENCH POLISH; SKI WAXES

1/00  Polishing compositions (French polish C09F 11/00; detergents C11D)
1/02  . containing abrasives or grinding agents {(abrasives as such C09K 3/14; polishing of semi-conductors H01L)}
1/04  . Aqueous dispersions (C09G 1/02 takes precedence)
1/06  . Other polishing compositions
1/08  . . based on wax
1/10  . . . based on mixtures of wax and natural or synthetic resin
1/12  . . . . mixtures of wax and silicon-containing polycondensates
1/14  . . based on non-waxy substances
1/16  . . . on natural or synthetic resins
1/18  . . . on other substances

3/00  Ski waxes